# **4-Bit Bus Switch**

The ON Semiconductor FST3125 is a quad, high performance switch. The device is CMOS TTL compatible when operating between 4 and 5.5 Volts. The device exhibits extremely low  $R_{ON}$  and adds nearly zero propagation delay. The device adds no noise or ground bounce to the system.

The device consists of four independent 1-bit switches with separate Output/Enable ( $\overline{OE}$ ) pins. Port A is connected to Port B when  $\overline{OE}$  is low. If  $\overline{OE}$  is high, the switch is high Z.

#### Features

- $R_{ON} < 4 \Omega$  Typical
- Less Than 0.25 ns–Max Delay Through Switch
- Nearly Zero Standby Current
- No Circuit Bounce
- Control Inputs are TTL/CMOS Compatible
- Pin-For-Pin Compatible With QS3125, FST3125, CBT3125
- All Popular Packages: TSSOP-14, SOIC-14
- These are Pb-Free Devices

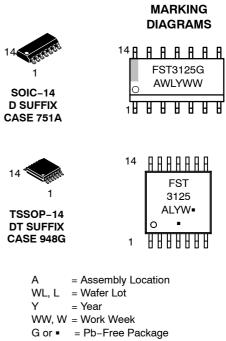
OE <sub>1</sub> -	1	$\bigcirc$	14	$-v_{cc}$
1A —	2		13	$-\overline{OE}_4$
1B —	3		12	— 4A
OE <sub>2</sub> -	4		11	— 4B
2A —	5		10	$-\overline{OE}_3$
2B —	6		9	— за
GND -	7		8	— 3B

Figure 1. Pin Assignment for SOIC and TSSOP



# **ON Semiconductor®**

http://onsemi.com



G	or∎ =	= Pb-Fre	e Packa	ge
(Note: N	licrodot	may be i	in either	location)

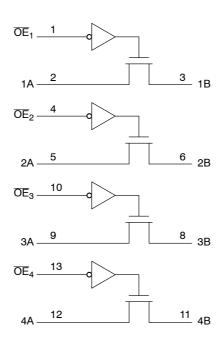
PIN NAMES			
Pin	Description		
$\overline{OE}_1, \overline{OE}_2, \overline{OE}_3, \overline{OE}_4$	Bus Switch Enables		
1A, 2A, 3A, 4A	Bus A		
1B, 2B, 3B, 4B	Bus B		
NC	Not Connected		

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# FST3125





# TRUTH TABLE

Inputs	Outputs
ŌĒ	А, В
L	A = B
Н	Z

## **ORDERING INFORMATION**

Device Order Number	Package	Shipping <sup>†</sup>
FST3125DR2G	SOIC-14 (Pb-Free)	2500 Units / Tape & Reel
FST3125DTR2G	TSSOP-14 (Pb-Free)	2500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **MAXIMUM RATINGS**

Symbol		Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +7.0	V
VI	DC Input Voltage		-0.5 to +7.0	V
Vo	DC Output Voltage		-0.5 to +7.0	V
Ι <sub>ΙΚ</sub>	DC Input Diode Current	$V_{I} < GND$	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	$V_{O} < GND$	-50	mA
Ι <sub>Ο</sub>	DC Output Sink Current		128	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin		±100	mA
I <sub>GND</sub>	DC Ground Current per Ground Pin		±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case	e for 10 Seconds	260	°C
TJ	Junction Temperature Under Bias		+ 150	°C
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC TSSOP	125 170	°C/W
MSL	Moisture Sensitivity		Level 1	
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	
V <sub>ESD</sub>	ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model	> 4000 > 400 > 2000	V
I <sub>Latchup</sub>	Latchup Performance	Above $V_{CC}$ and Below GND at 85°C (Note 4)	±100	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.

Tested to EIA/JESD22-A114-A.
 Tested to EIA/JESD22-A115-A.

4. Tested to EIA/JESD78.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Par	ameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating, Data Retention Only	4.0	5.5	V
VI	Input Voltage	(Note )	0	5.5	V
Vo	Output Voltage	(HIGH or LOW State)	0	5.5	V
T <sub>A</sub>	Operating Free-Air Temperature		-55	+125	°C
$\Delta t / \Delta V$	Input Transition Rise or Fall Rate	Switch Control Input Switch I/O	0 0	5 DC	ns/V

5. Unused control inputs may not be left open. All control inputs must be tied to a high- or low-logic input voltage level.

## **DC ELECTRICAL CHARACTERISTICS**

			V <sub>CC</sub>	T <sub>A</sub> = -	55°C to +	·125°C	
Symbol	Parameter	Conditions	(V)	Min	Тур*	Max	Unit
V <sub>IK</sub>	Clamp Diode Resistance	I <sub>IN</sub> = -18mA	4.5			-1.2	V
V <sub>IH</sub>	High-Level Input Voltage		4.0 to 5.5	2.0			V
V <sub>IL</sub>	Low-Level Input Voltage		4.0 to 5.5			0.8	V
I <sub>I</sub>	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	5.5			±1.0	μΑ
I <sub>OZ</sub>	OFF-STATE Leakage Current	$0 \le A, B \le V_{CC}$	5.5			±1.0	μΑ
R <sub>ON</sub>	Switch On Resistance (Note 6)	$V_{IN} = 0 \text{ V}, \text{ I}_{IN} = 64 \text{ mA}$	4.5		4	7	Ω
		V <sub>IN</sub> = 0 V, I <sub>IN</sub> = 30 mA	4.5		4	7	1
		V <sub>IN</sub> = 2.4 V, I <sub>IN</sub> = 15 mA	4.5		8	15	1
		V <sub>IN</sub> = 2.4 V, I <sub>IN</sub> = 15 mA	4.0		11	20	1
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	5.5			3	μA
$\Delta I_{CC}$	Increase In I <sub>CC</sub> per Input	One input at 3.4 V, Other inputs at $V_{CC}$ or GND	5.5			2.5	mA

\*Typical values are at  $V_{CC} = 5.0$  V and  $T_A = 25^{\circ}C$ . 6. Measured by the voltage drop between A and B pins at the indicated current through the switch.

## **AC ELECTRICAL CHARACTERISTICS**

				Limits				
				T <sub>A</sub> = −55°C to +125°C				
				V <sub>CC</sub> = 4.5	5 to 5.5 V	V <sub>CC</sub> =	4.0 V	
Symbol	Parameter	Conditions	Figures	Min	Max	Min	Max	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Prop Delay Bus to Bus (Note 7)	V <sub>I</sub> = OPEN	3 and 4		0.25		0.25	ns
t <sub>PZH</sub> , t <sub>PZL</sub>	Output Enable Time	$V_I = 7 V \text{ for } t_{PZL}$ $V_I = OPEN \text{ for } t_{PZH}$	3 and 5	1.0	5.0		5.5	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Output Disable Time	$V_I = 7 V \text{ for } t_{PLZ}$ $V_I = OPEN \text{ for } t_{PHZ}$	3 and 5	1.5	5.3		5.6	ns

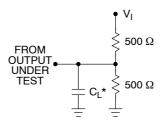
7. This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

## CAPACITANCE (Note 8)

Symbol	Parameter	Conditions	Тур	Мах	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> = 5.0 V	3		pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CC}, \overline{OE} = 5.0 \text{ V}$	5		pF

8.  $T_A = +25^{\circ}C$ , f = 1 MHz, Capacitance is characterized but not tested.

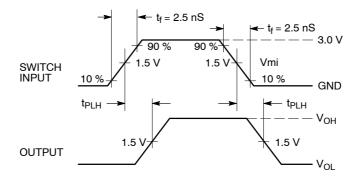
#### AC Loading and Waveforms



NOTES:

1. Input driven by 50  $\Omega$  source terminated in 50  $\Omega.$  2. CL includes load and stray capacitance. \*CL = 50 pF







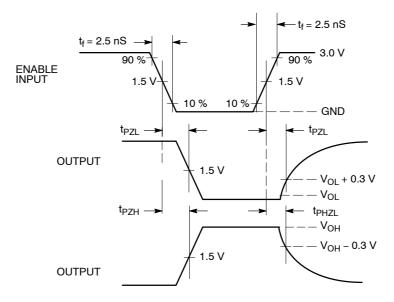


Figure 5. Enable/Disable Delays





\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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